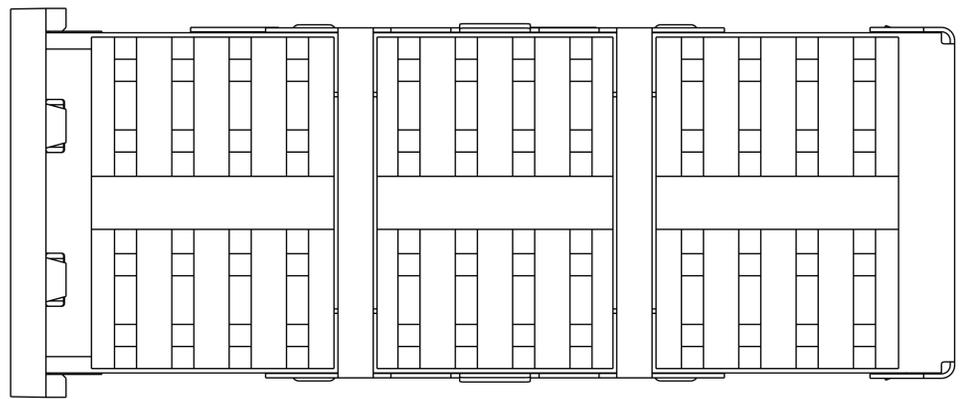
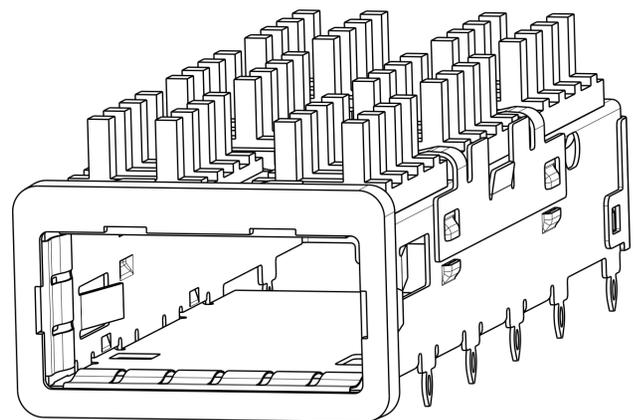
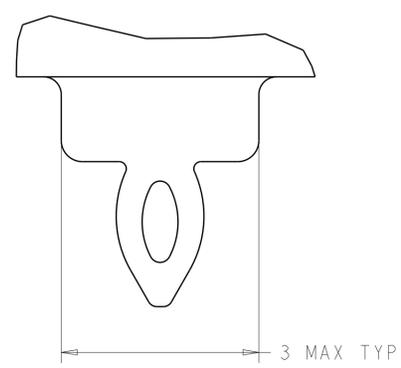
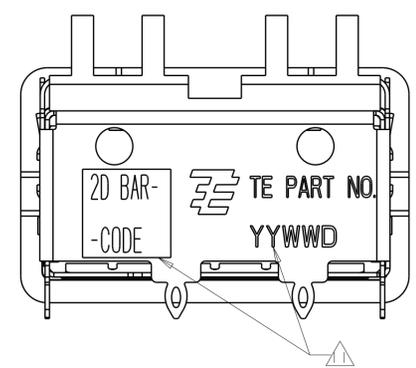
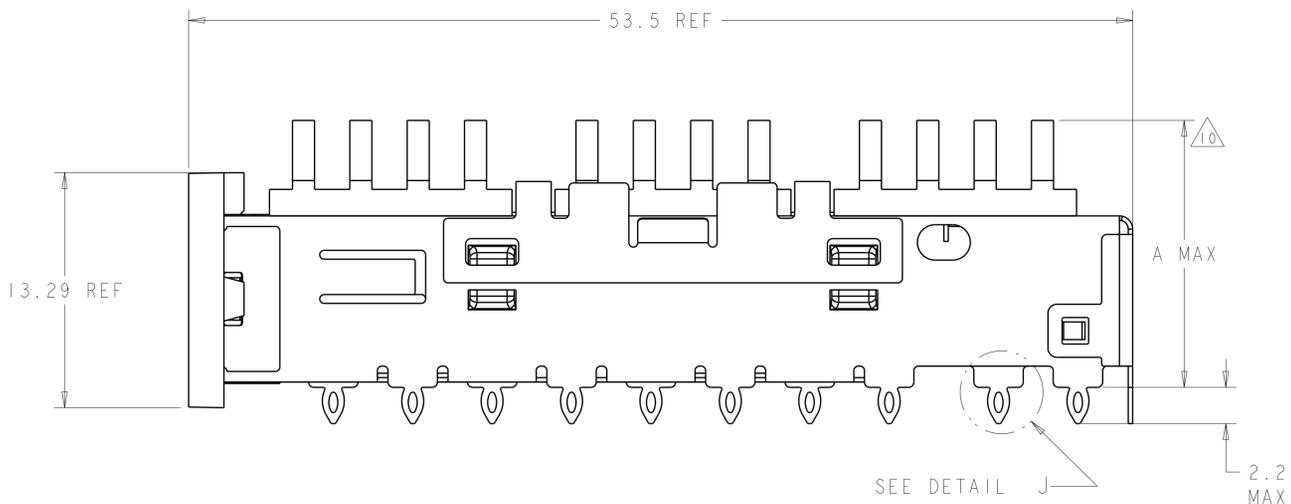
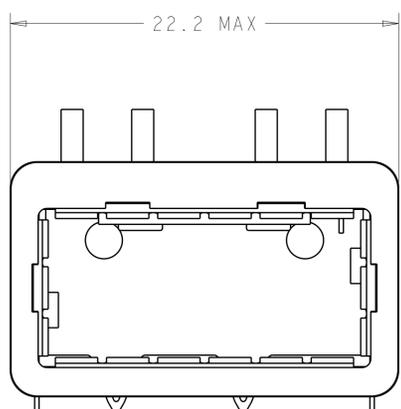


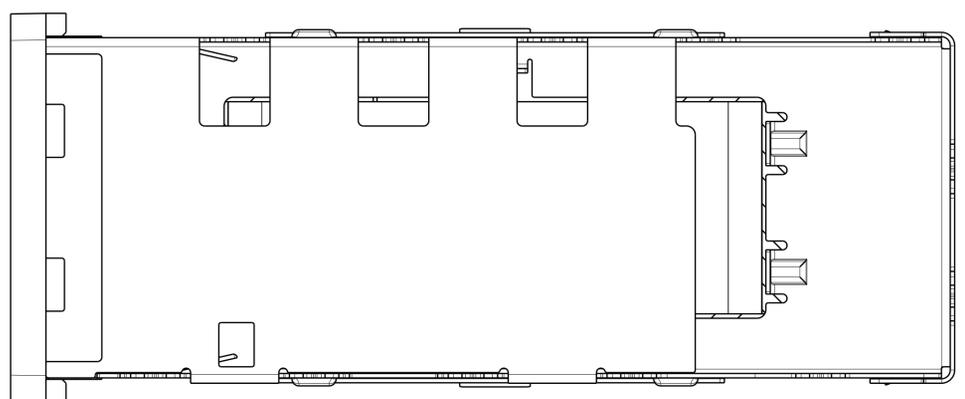
REVISIONS				
REV	LTN	DESCRIPTION	DATE	APVD
B1	REV PER	ECO-14-016878	24NOV2014	RG MC



- 1 CAGE MATERIAL: NICKEL SILVER, 0.25 THICK
 HEAT SINK MATERIAL: ALUMINUM
 HEAT SINK CLIP MATERIAL: STAINLESS STEEL
 EMI SPRING MATERIAL: COPPER ALLOY
 FRONT FLANGE MATERIAL: ZINC ALLOY
- 2 MINIMUM PITCH DIMENSION.
- 3. MATES WITH QSFP MSA COMPATIBLE TRANSCEIVER.
- 4 REFERENCE APPLICATION SPEC 114-13218 FOR RECOMMENDED DRILL HOLE DIAMETER AND PLATING THICKNESS.
- 5 DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- 6 DIMENSION C IS THE NOMINAL THICKNESS OF CUSTOMER SUPPLIED PC BOARD,
 SINGLE SIDED PC BOARD MINIMUM THICKNESS: 1.45
 DOUBLE SIDED PC BOARD MINIMUM THICKNESS: 2.7.
- 7 HEAT SINK AND CLIP SHIPPED ASSEMBLED TO CAGE ASSEMBLY
 CAGE ASSEMBLY MAY BE PRESSED INTO THE PCB AS SHIPPED.
- 8 DATUM -A- IS TOP SURFACE OF HOST BOARD.
- 9 SURFACE TRACES PERMITTED WITHIN THIS AREA EXCEPT WHERE CAGE STANDOFFS, SHOWN IN DETAIL J, CONTACT PC BOARD.
- 10 DIMENSION APPLIES WITH MODULE INSTALLED IN THE CAGE.
- 11 2D BARCODE AND DATE CODE (YYWWD) MARKED ON BACK OF CAGE.
- 12 EMI SPRING FINISH: 2µm MIN TIN.
 FRONT FLANGE FINISH: 3µm MIN TIN OVER 1.27µm MIN NICKEL
 OVER 5.08µm MIN COPPER.
 HEAT SINK FINISH: 0.076µm MIN NICKEL.



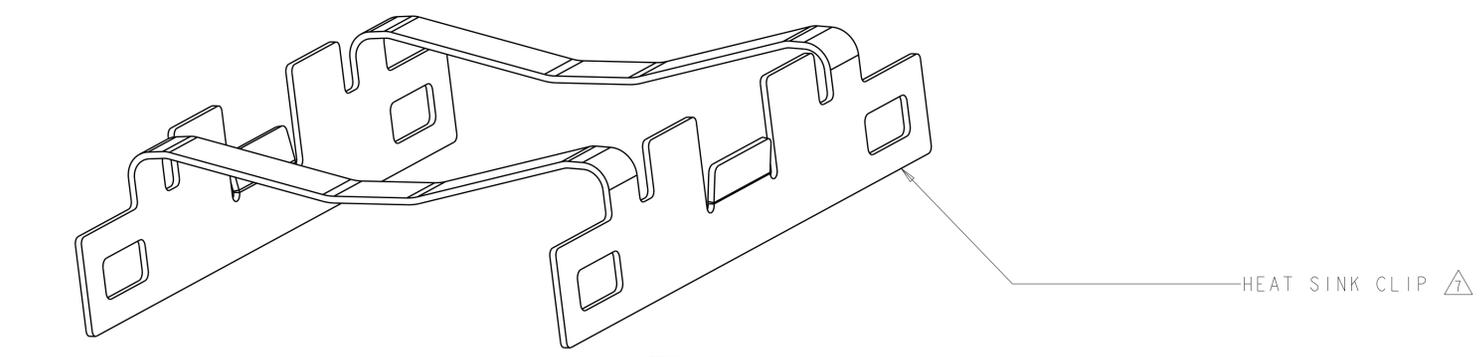
DETAIL J
 SCALE 20:1



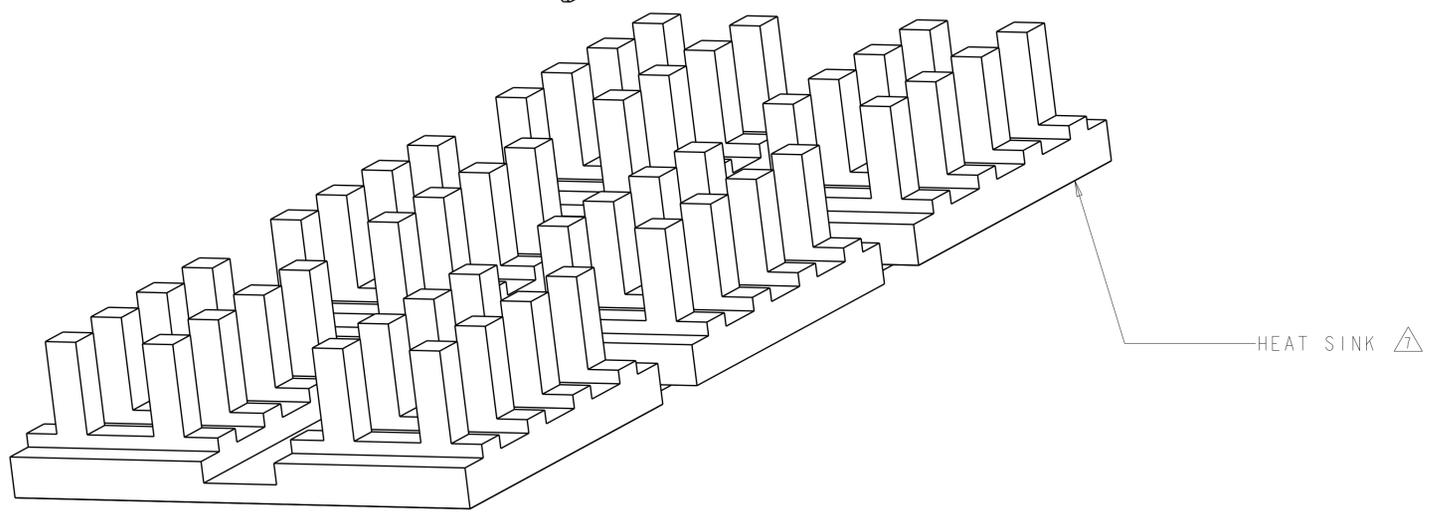
23.0	NETWORKING HEAT SINK	1888968-3
16.0	SAN HEAT SINK (SHOWN)	1888968-2
13.7	PCI HEAT SINK	1888968-1
A	DESCRIPTION	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN C. VALENTINE 19FEB2007	TE Connectivity
DIMENSIONS:		CHK E. BRIGHT 19FEB2007	
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD E. BRIGHT 19FEB2007	NAME
0 PLC ±0.5	1 PLC ±0.13	PRODUCT SPEC	CAGE ASSEMBLY, BEHIND BEZEL, QSFP WITH HEAT SINK
2 PLC ±0.13	3 PLC ±0.013	APPLICATION SPEC	
4 PLC ±0.0001	ANGLES ±0.0001	114-13218	SIZE CAGE CODE DRAWING NO
MATERIAL	FINISH	WEIGHT	A100779C=1888968
		CUSTOMER DRAWING	RESTRICTED TO
		SCALE 5:1	SHEET 1 OF 5

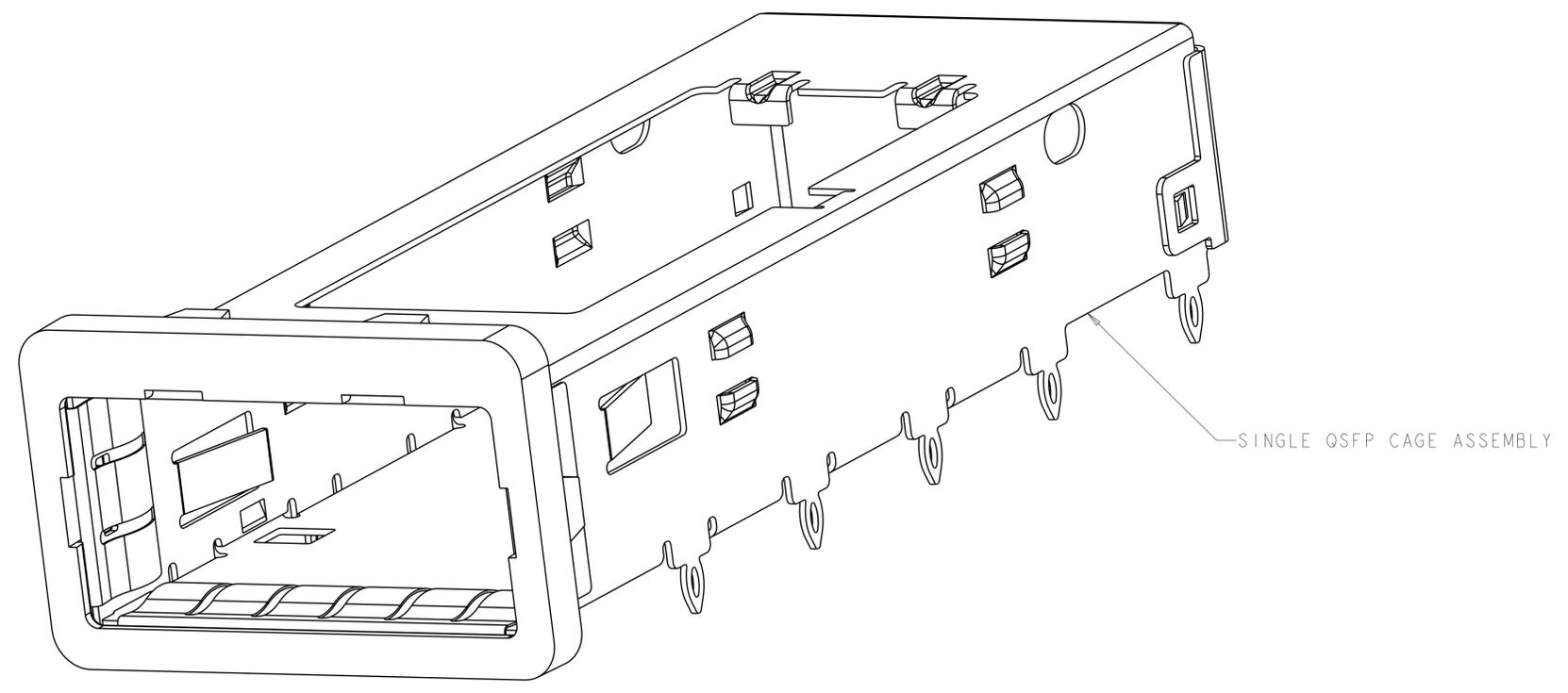
REVISIONS				
P.	LTN	DESCRIPTION	DATE	OWN APVD
-	-	SEE SHEET 1	-	-



HEAT SINK CLIP



HEAT SINK

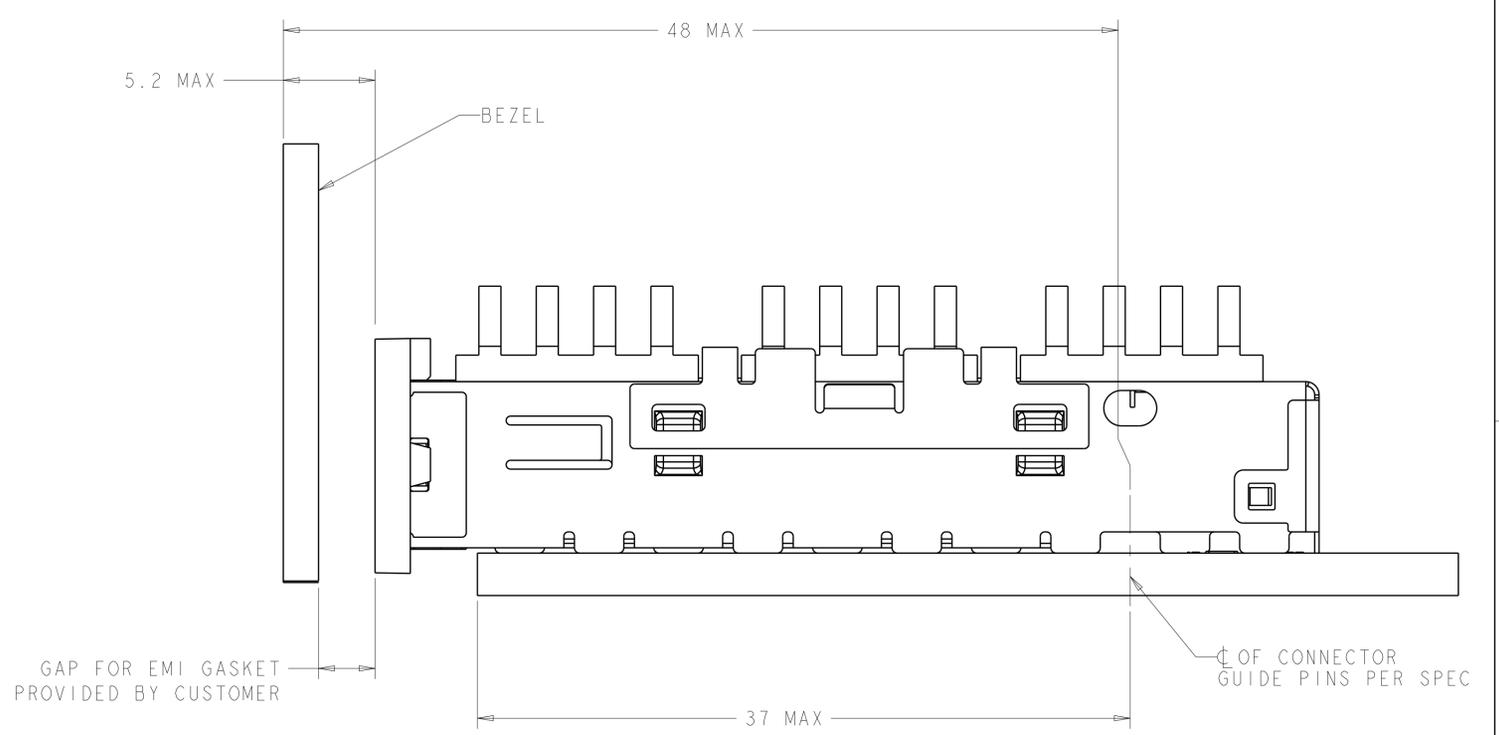
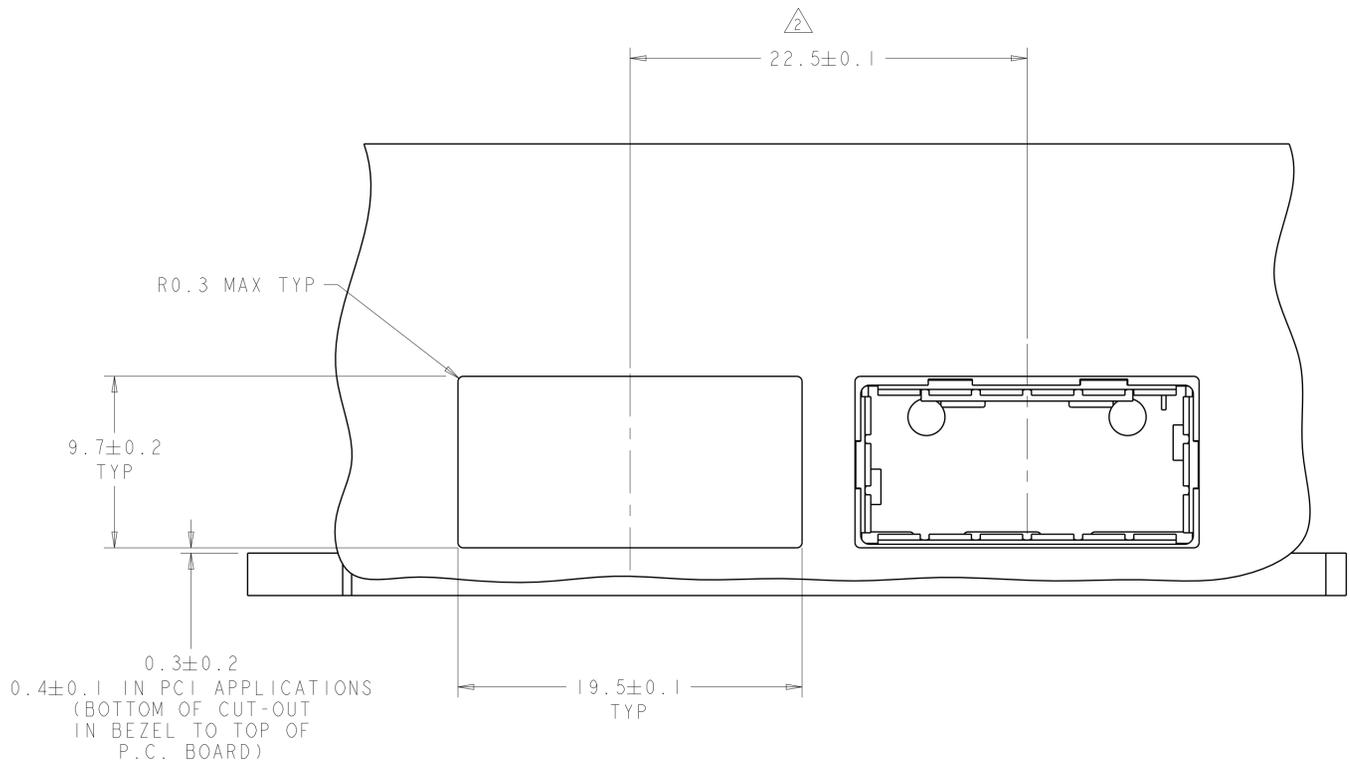


SINGLE QSFP CAGE ASSEMBLY

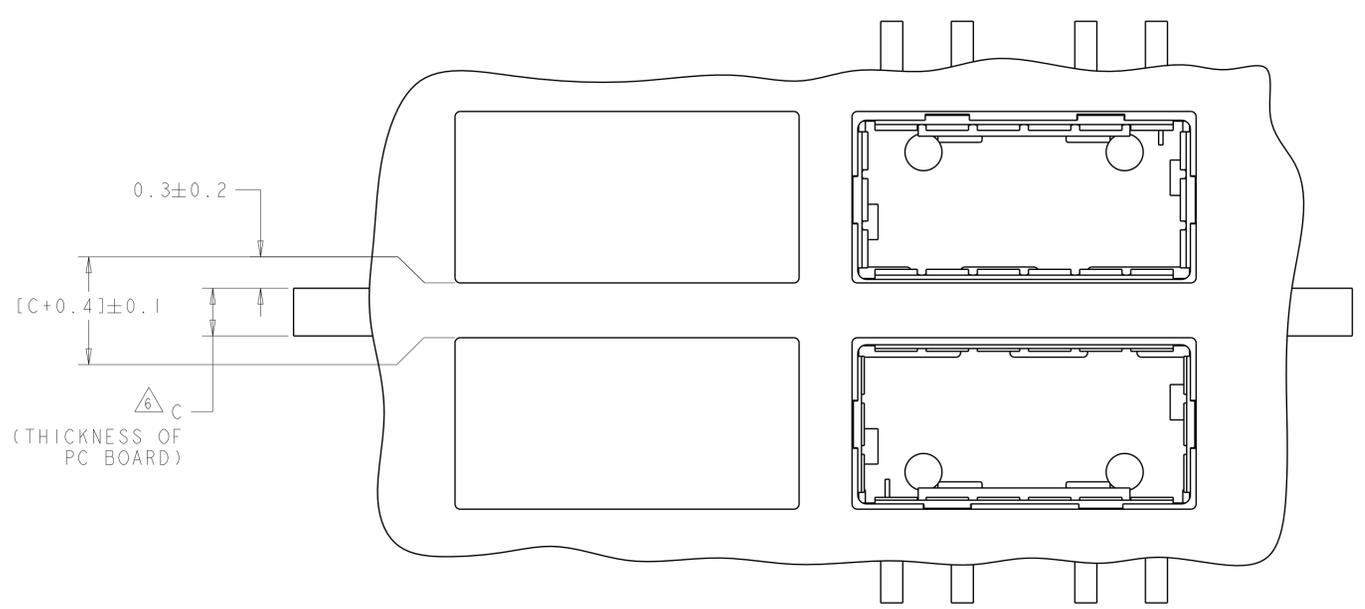
EXPLODED VIEW
SCALE 8:1

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN C. VALENTINE 19FEB2007	TE Connectivity NAME CAGE ASSEMBLY, BEHIND BEZEL, QSFP, WITH HEAT SINK PRODUCT SPEC 108-2286 APPLICATION SPEC 114-13218 WEIGHT - CUSTOMER DRAWING	SIZE A1	CAGE CODE 00779	DRAWING NO C=1888968	RESTRICTED TO -	
DIMENSIONS:		CHK E. BRIGHT 19FEB2007		APVD E. BRIGHT 19FEB2007	SCALE 5:1	SHEET 2	OF 5	REV B1
TOLERANCES UNLESS OTHERWISE SPECIFIED:		0 PLC ± 1 PLC ±0.5 2 PLC ±0.13 3 PLC ±0.013 4 PLC ±0.001 ANGLES ±						
MATERIAL		FINISH						

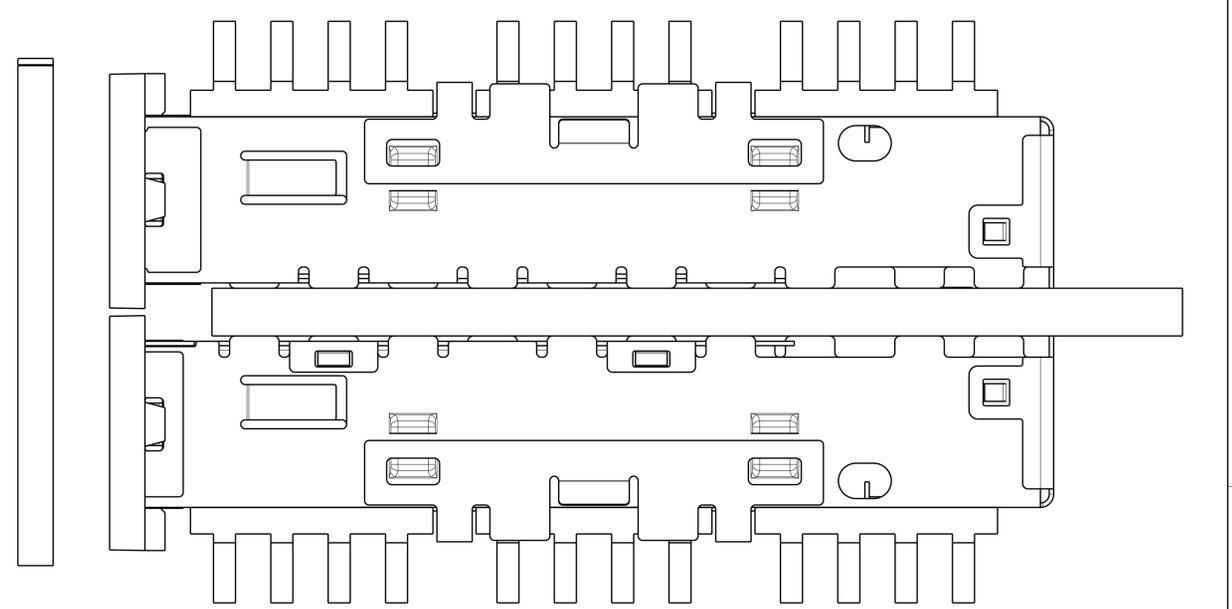
REVISIONS				
P.	LTH	DESCRIPTION	DATE	APVD
-	-	SEE SHEET 1	-	-



ONE SIDED CONFIGURATION

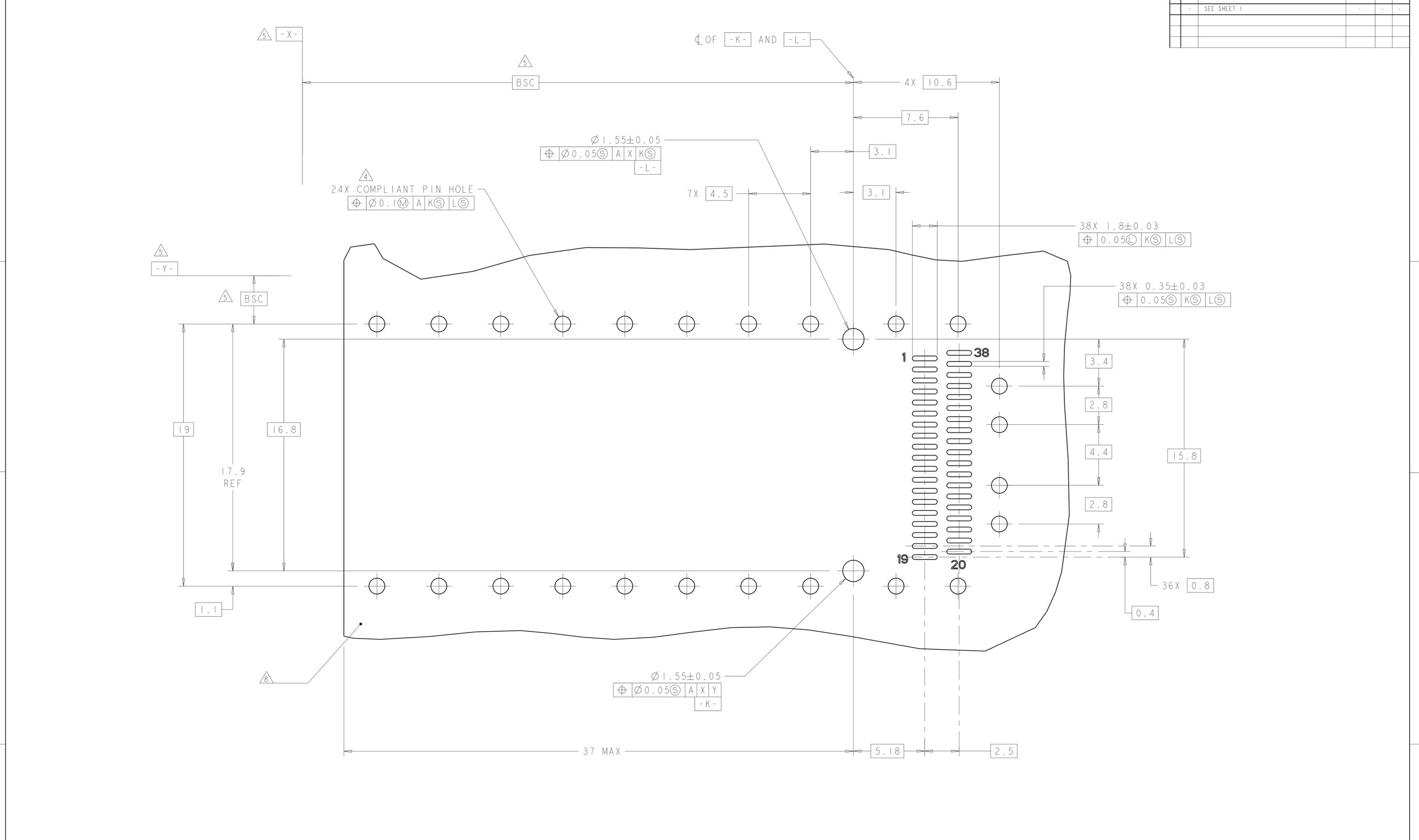


BELLY TO BELLY CONFIGURATION
SIMILAR TO ONE SIDED EXCEPT
WHERE NOTED



THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN C. VALENTINE 19FEB2007 CHK E. BRIGHT 19FEB2007 APVD E. BRIGHT 19FEB2007	TE Connectivity NAME CAGE ASSEMBLY, BEHIND BEZEL, QSFP, WITH HEAT SINK PRODUCT SPEC 108-2286 APPLICATION SPEC 114-13218 WEIGHT - CUSTOMER DRAWING	SIZE CAGE CODE DRAWING NO A100779C=1888968	RESTRICTED TO
DIMENSIONS: mm 	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±0.5 2 PLC ±0.13 3 PLC ±0.013 4 PLC ±0.0001 ANGLES ±0.0001	SCALE 5:1 SHEET 3 OF 5 REV B1			

REVISIONS				
P.	LTN.	DESCRIPTION	DATE	APPD.
-	-	SEE SHEET 1	-	-



RECOMMENDED PCB LAYOUT
 BELLY TO BELLY CONFIGURATION
 SEE SHEET 4 FOR KEEP OUT AREAS
 SCALE 8:1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN C. VALENTINE 19FEB2007 CHK E. BRIGHT 19FEB2007 APVD E. BRIGHT 19FEB2007	TE Connectivity
DIMENSIONS: mm 	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±0.5 2 PLC ±0.13 3 PLC ±0.013 4 PLC ±0.001 ANGLES ±0.0001	NAME CAGE ASSEMBLY, BEHIND BEZEL, QSFP WITH HEAT SINK PRODUCT SPEC 108-2286 APPLICATION SPEC 114-13218 WEIGHT - CUSTOMER DRAWING	

Данный компонент на территории Российской Федерации

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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